Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product Information in this Catalog

Product information in this catalog is as of January 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for generalpurpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, dataprocessing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *²

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
 (2) Million
- (6) Military equipment
- Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

*Notes:

- There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
- Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.

TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

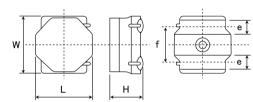
Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

PARTS NUMB	ER	*Operating Temp	.:-40~
M D K	K 1 6 1 6 T 1 R 0 M 3 4 5 6		ank spa
①Series name		⑤Nominal induct	ance
Code	Series name	Code	
MD	Metal base coil specification	(example)	
		R47	
2Dimensions(H)	1R0	
Code	Dimensions(H)[mm]	4R7	
JE	0.95	ℜR=Decimal po	oint
KK	1.0		
MK	1.2	⑥Inductance tole	erance
PK	1.4	Code	
WK	2.0	М	
		Ν	
③Dimensions(L	×W)		
Code	Dimensions $(L \times W)$ [mm]	⑦Special code	
1616	1.6 × 1.6	Code	
2020	2.0 × 2.0	F	
	· · · · · · · · · · · · · · · · · · ·		

3030 3.0×3.0 4040 4.0×4.0 5050 4.9×4.9

④Packaging	
Code	Packaging
Т	Taping

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



 (0.193 ± 0.008)

 (0.193 ± 0.008)

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(8)Internal code

Туре	А	В	С
1616	0.5	1.10	1.65
2020	0.65	1.35	2.0
3030	0.8	2.2	2.7
4040	1.2	2.8	3.7
5050	1.5	3.6	4.2
			Unit:mm

 (0.130 ± 0.008)

Standard quantity Type Т W н е f [pcs] Taping 1.64 ± 0.1 1.64 ± 0.1 1.0 max 0.40 +0.2/-0.1 1.0 ± 0.2 MDKK1616 2500 (0.065 ± 0.004) (0.065 ± 0.004) (0.039 max) (0.016 +0.008/-0.004) (0.039 ± 0.008) 2.0 ± 0.15 2.0 ± 0.15 0.95 max 0.50 ± 0.2 1.25 ± 0.2 MDJE2020 2500 (0.079 ± 0.006) (0.079 ± 0.006) (0.037 max) (0.02 ± 0.008) (0.049 ± 0.008) 2.0 ± 0.15 2.0 ± 0.15 1.0 max 0.50 ± 0.2 1.25 ± 0.2 MDKK2020 2500 (0.079 ± 0.006) (0.079 ± 0.006) (0.039 max) (0.02 ± 0.008) (0.049 ± 0.008) 2.0 ± 0.15 2.0 ± 0.15 1.2 max 0.50 ± 0.2 1.25 ± 0.2 MDMK2020 2500 (0.079 ± 0.006) (0.079 ± 0.006) (0.02 ± 0.008) (0.049 ± 0.008) (0.047 max) 3.0 ± 0.1 3.0 ± 0.1 1.0 max 0.90 ± 0.2 1.9 ± 0.2 MDKK3030 2000 (0.118 ± 0.004) (0.039 max) (0.075 ± 0.008) (0.118 ± 0.004) (0.035 ± 0.008) 3.0 ± 0.1 3.0 ± 0.1 0.90 ± 0.2 1.9 ± 0.2 1.2 max MDMK3030 2000 (0.118 ± 0.004) (0.118 ± 0.004) (0.047 max) (0.035 ± 0.008) (0.075 ± 0.008) 0.95 max 4.0 ± 0.2 4.0 ± 0.2 1.1 ± 0.2 2.5 ± 0.2 MDJE4040 1000 (0.157 ± 0.008) (0.157 ± 0.008) (0.037 max) (0.043 ± 0.008) (0.098 ± 0.008) 40 + 0240 + 0212 max 11 + 02 25 ± 02 MDMK4040 1000 (0.157 ± 0.008) (0.157 ± 0.008) (0.047 max) (0.043 ± 0.008) (0.098 ± 0.008) 4.0 ± 0.2 4.0 ± 0.2 2.0 max 1.1 ± 0.2 2.5 ± 0.2 MDWK4040 700 (0.157 ± 0.008) (0.157 ± 0.008) (0.079 max) (0.043 ± 0.008) (0.098 ± 0.008) 4.9 ± 0.2 4.9 ± 0.2 1.4 max 1.20 ± 0.2 3.3 ± 0.2 MDPK5050 1000

Unit:mm(inch)

> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/)

(0.055 max)

 (0.047 ± 0.008)

REFLOW

g Temp.:-40~+125°C(Including self-generated heat)

Nominal inductance $[\mu H]$

0 4 7 1.0 4.7

Inductance tolerance

Special code Ferrite coating Metal coating

±20% $\pm 30\%$

 $\Delta = Blank space$

for General Electronic Equipment

PARTS NUMBER

MDKK1616 type		【Thickness:1.0mm	max.]							
		Manufact Induction		DO Durin	tance[Ω]		Rated currer	nt ※)[mA]		Manualan
Parts number	EHS	Nominal inductance [μH]	Inductance tolerance	DC Resis	tance[s2]	Saturation (current: Idc1	Temperature ri	se current: Idc2	Measuring frequency[MHz]
		Linij		Max.	Typ.	Max.	Typ.	Max.	Тур.	In equency [IVII I2]
MDKK1616TR47MM	RoHS	0.47	±20%	0.095	0.080	3,300	4,100	1,500	1,780	1
MDKK1616T1R0MM	RoHS	1.0	±20%	0.140	0.120	2,200	2,750	1,200	1,490	1
MDKK1616T1R5MM	RoHS	1.5	±20%	0.185	0.160	1,750	2,200	1,100	1,330	1
MDKK1616T2R2MM	RoHS	2.2	±20%	0.250	0.215	1,500	1,800	950	1,110	1
MDKK1616T3R3MM	RoHS	3.3	±20%	0.515	0.450	1,150	1,450	650	730	1
MDKK1616T4R7MM	RoHS	4.7	±20%	0.640	0.550	950	1,200	550	630	1
MDKK1616T6R8MM	RoHS	6.8	±20%	0.820	0.710	630	880	520	600	1
MDKK1616T100MM	RoHS	10	±20%	1.120	0.970	550	800	450	500	1
MDKK1616T150MM	RoHS	15	±20%	1.800	1.600	460	640	400	440	1

MDJE2020 type [Thickness: 0.95mm max.]

		Nominal inductance		DC Resist			Rated curren	t 💥) [mA]		Measuring	
Parts number	EHS	[µ H]	Inductance tolerance	DU Resis	ance[32]	Saturation of	current: Idc1	Temperature ri	se current: Idc2	frequency[MHz]	
		2,215		Max.	Typ.	Max.	Typ.	Max.	Typ.	in equelley [iii i2]	
MDJE2020T1R0MM	RoHS	1.0	±20%	0.121	0.106	3,100	3,800	1,550	1,800	1	
MDJE2020T2R2MM	RoHS	2.2	±20%	0.266	0.230	1,550	1,900	1,050	1,200	1	
MDJE2020T3R3MM	RoHS	3.3	±20%	0.340	0.290	1,350	1,600	950	1,100	1	
MDJE2020T4R7MM	RoHS	4.7	±20%	0.475	0.410	1,200	1,550	850	950	1	
MDJE2020T6R8MM	RoHS	6.8	±20%	0.630	0.550	800	1,100	750	850	1	
MDJE2020T100MM	RoHS	10	±20%	1.040	0.910	700	900	550	600	1	

MDKK2020 type [Thickness: 1.0mm max.]

		Nominal inductance		DC Resist	101		Rated curren	t ※)[mA]		Manager
Parts number	EHS	ivominal inductance [μH]	Inductance tolerance	DC Resis	rauce [32]	Saturation of	current: Idc1	Temperature ri	se current: Idc2	Measuring frequency[MHz]
		L M HIJ		Max.	Typ.	Max.	Typ.	Max.	Тур.	In equency [IIII 12]
MDKK2020TR47MM	RoHS	0.47	±20%	0.046	0.040	3,500	4,150	2,200	2,500	1
MDKK2020TR68MM	RoHS	0.68	±20%	0.060	0.052	3,200	3,650	2,000	2,100	1
MDKK2020T1R0MM	RoHS	1.0	±20%	0.085	0.074	2,900	3,400	1,700	1,900	1
MDKK2020T1R5MM	RoHS	1.5	±20%	0.133	0.115	1,900	2,250	1,350	1,500	1
MDKK2020T2R2MM	RoHS	2.2	±20%	0.165	0.139	1,650	1,950	1,200	1,350	1
MDKK2020T3R3MM	RoHS	3.3	±20%	0.275	0.240	1,300	1,550	940	1,050	1
MDKK2020T4R7MM	RoHS	4.7	±20%	0.435	0.375	1,050	1,250	750	850	1
MDKK2020T100MM	RoHS	10	±20%	0.690	0.600	750	900	630	680	1
MDKK2020T150MM	RoHS	15	±20%	1.180	1.020	550	750	480	550	1

MDMK2020 type [Thickness:1.2mm max.]

		Nominal inductance		DC Resist	101		Rated curren			Measuring
Parts number	EHS	[µ H]	Inductance tolerance	DC Resis	DO Resistance[32]		Saturation current: Idc1		se current: Idc2	Measuring frequency[MHz]
		L M HIJ		Max.	Typ.	Max.	Тур.	Max.	Тур.	In equency [IIII 12]
MDMK2020TR47MM	RoHS	0.47	±20%	0.046	0.040	4,200	4,800	2,300	2,450	1
MDMK2020TR68MM	RoHS	0.68	±20%	0.058	0.050	3,500	4,100	2,000	2,200	1
MDMK2020T1R0MM	RoHS	1.0	±20%	0.064	0.056	2,550	2,900	1,900	2,050	1
MDMK2020T1R5MM	RoHS	1.5	±20%	0.086	0.075	2,000	2,300	1,650	1,750	1
MDMK2020T2R2MM	RoHS	2.2	±20%	0.109	0.095	1,750	2,000	1,450	1,550	1
MDMK2020T3R3MM	RoHS	3.3	±20%	0.178	0.155	1,350	1,550	1,150	1,200	1
MDMK2020T4R7MM	RoHS	4.7	±20%	0.242	0.210	1,150	1,300	950	1,050	1

MDKK3030 type [Thickness: 1.0mm max.]

		Nominal inductance		DC Resis	101		Rated currer	nt ※)[mA]		Measuring	
Parts number	EHS	[µ H]	Inductance tolerance	DC Resis	rauce[22]	Saturation	on current: Idc1 Temperature rise curre		se current: Idc2	dc2 frequency [MHz]	
		L M HI		Max.	Typ.	Max.	Typ.	Max.	Typ.	In equency [Initiz]	
MDKK3030TR47MM	RoHS	0.47	±20%	0.039	0.033	5,400	6,500	3,900	4,500	1	
MDKK3030T1R0MM	RoHS	1.0	±20%	0.086	0.074	4,400	5,200	2,400	2,800	1	
MDKK3030T1R5MM	RoHS	1.5	±20%	0.100	0.087	3,000	3,500	2,100	2,400	1	
MDKK3030T2R2MM	RoHS	2.2	±20%	0.144	0.125	2,500	3,000	1,900	2,200	1	
MDKK3030T3R3MM	RoHS	3.3	±20%	0.248	0.215	2,000	2,400	1,350	1,500	1	
MDKK3030T4R7MM	RoHS	4.7	±20%	0.345	0.300	1,700	2,000	1,150	1,300	1	
MDKK3030T6R8MM	RoHS	6.8	±20%	0.437	0.380	1,400	1,700	1,000	1,150	1	
MDKK3030T100MM	RoHS	10	±20%	0.575	0.500	1,100	1,300	850	1,000	1	

MDMK3030 type

【Thickness:1.2mm max.】

		Nominal inductance		DC Resist	tanaa [0]		Rated curren	t ※)[mA]		Measuring	
Parts number	EHS	[µ H]	Inductance tolerance	DO Resis	DO Resistance[1:]		current: Idc1	Temperature rise current: Idc2		frequency[MHz]	
		L M HIJ		Max.	Typ.	Max.	Тур.	Max.	Тур.	In equency [IIII 12]	
MDMK3030TR30MM	RoHS	0.30	±20%	0.020	0.017	7,600	9,200	5,500	6,400	1	
MDMK3030TR33MM	RoHS	0.33	±20%	0.020	0.017	6,400	8,700	5,500	6,400	1	
MDMK3030TR47MM	RoHS	0.47	±20%	0.027	0.023	6,300	7,500	4,700	5,500	1	
MDMK3030T1R0MM	RoHS	1.0	±20%	0.050	0.043	4,300	5,100	3,300	3,900	1	
MDMK3030T1R5MM	RoHS	1.5	±20%	0.074	0.064	3,400	4,100	2,500	3,000	1	
MDMK3030T2R2MM	RoHS	2.2	±20%	0.112	0.097	2,800	3,600	2,100	2,400	1	
MDMK3030T3R3MM	RoHS	3.3	±20%	0.167	0.145	2,100	2,700	1,650	1,900	1	
MDMK3030T4R7MM	RoHS	4.7	±20%	0.263	0.228	1,800	2,300	1,350	1,550	1	

PARTS NUMBER

MDJE4040 type [Thickness:0.95mm max.]

		Nominal inductance		DO Durin	tance[Ω]		Rated currer	t ※)[mA]		Measuring	
Parts number	EHS	Nominal Inductance	Inductance tolerance	DC Resis	tance[s2]	Saturation (current: Idc1	Temperature rise current: Idc2		frequency[MHz]	
		L M HIJ		Max.	Typ.	Max.	Typ.	Max.	Тур.	In equency [IVII I2]	
MDJE4040TR47MM	RoHS	0.47	±20%	0.040	0.035	6,000	7,900	4,000	4,500	1	
MDJE4040T1R0MM	RoHS	1.0	±20%	0.069	0.060	4,700	5,700	3,000	3,500	1	
MDJE4040T1R5MM	RoHS	1.5	±20%	0.084	0.073	3,000	4,000	2,700	3,100	1	
MDJE4040T2R2MM	RoHS	2.2	±20%	0.115	0.100	2,400	3,100	2,400	2,700	1	
MDJE4040T3R3MM	RoHS	3.3	±20%	0.200	0.175	2,000	2,600	1,800	2,000	1	
MDJE4040T4R7MM	RoHS	4.7	±20%	0.250	0.220	1,900	2,300	1,600	1,900	1	
MDJE4040T6R8MM	RoHS	6.8	±20%	0.370	0.320	1,500	1,800	1,300	1,500	1	
MDJE4040T100MM	RoHS	10	±20%	0.510	0.440	1,400	1,700	1,100	1,300	1	

MDMK4040F type [Thickness: 1.2mm max.]

		Nominal inductance			ance[Ω]		Rated curren	t 💥) [mA]		Measuring	
Parts number	EHS	[µ H]	Inductance tolerance	DC Resis	ance[32]	Saturation of	current: Idc1	Temperature ri	se current: Idc2	frequency[kHz]	
		LANJ		Max.	Typ.	Max.	Typ.	Max.	Typ.	Inequency [KI12]	
MDMK4040TR47MF	RoHS	0.47	±20%	0.029	0.025	7,500	10,000	4,600	5,400	100	
MDMK4040T1R0MF	RoHS	1.0	±20%	0.047	0.041	5,200	7,500	3,500	4,200	100	
MDMK4040T1R2MF	RoHS	1.2	±20%	0.047	0.041	4,200	6,200	3,500	4,200	100	
MDMK4040T1R5MF	RoHS	1.5	±20%	0.065	0.056	3,700	5,400	3,300	3,600	100	
MDMK4040T2R2MF	RoHS	2.2	±20%	0.092	0.080	3,200	4,500	2,500	2,900	100	

MDMK4040 type [Thickness: 1.2mm max.]

			Nominal inductance		Inductance tolerance DC Resistance[Ω]		Rated current 💥) [mA]				Measuring
	Parts number	EHS	[µ H]	Inductance tolerance			Saturation current: Idc1		Temperature rise current: Idc2		frequency [MHz]
			L M HI		Max.	Typ.	Max.	Typ.	Max.	Typ.	In order on a final state
Ī	MDMK4040TR68MM	RoHS	0.68	±20%	0.029	0.025	6,700	7,800	5,000	5,700	1
Ī	MDMK4040T1R0MM	RoHS	1.0	±20%	0.036	0.031	5,000	6,200	4,500	5,100	1
ī	MDMK4040T1R5MM	RoHS	1.5	±20%	0.065	0.056	4,500	5,600	3,200	3,600	1
	MDMK4040T2R2MM	RoHS	2.2	±20%	0.079	0.069	3,800	4,500	2,800	3,200	1
Ī	MDMK4040T3R3MM	RoHS	3.3	±20%	0.130	0.113	3,200	4,000	2,200	2,500	1
ī	MDMK4040T4R7MM	RoHS	4.7	±20%	0.160	0.140	2,500	3,000	1,900	2,200	1
Ē	MDMK4040T6R8MM	RoHS	6.8	±20%	0.230	0.200	1,900	2,200	1,600	1,800	1
- J	MDMK4040T100MM	RoHS	10	±20%	0.330	0.280	1,700	2,000	1,400	1,600	1

MDWK4040 type [Thickness: 2.0mm max.]

	Nominal inductance		DC Resistance[Ω]		Rated current ※)[mA]				Managering	
Parts number EH	EHS	EHS [µH]	Inductance tolerance	DO Resistance[22]		Saturation current: Idc1		Temperature rise current: Idc2		Measuring frequency[MHz]
		L M H		Max.	Typ.	Max.	Typ.	Max.	Typ.	In equency [IIII12]
MDWK4040TR33NM	RoHS	0.33	±30%	0.013	0.011	16,000	21,000	7,800	8,800	1
MDWK4040TR47NM	RoHS	0.47	±30%	0.013	0.011	10,000	15,000	7,800	8,800	1
MDWK4040TR56NM	RoHS	0.56	±30%	0.016	0.014	9,000	13,000	6,500	7,500	1
MDWK4040TR68MM	RoHS	0.68	±20%	0.016	0.014	8,000	12,000	7,300	8,300	1
MDWK4040T1R0MM	RoHS	1.0	±20%	0.027	0.023	7,000	9,400	5,100	5,800	1
MDWK4040T1R5MM	RoHS	1.5	±20%	0.041	0.035	7,000	9,400	4,100	4,700	1
MDWK4040T2R2MM	RoHS	2.2	±20%	0.054	0.047	5,400	7,500	3,500	4,000	1
MDWK4040T3R3MM	RoHS	3.3	±20%	0.075	0.066	3,700	5,200	3,000	3,300	1
MDWK4040T4R7MM	RoHS	4.7	±20%	0.107	0.093	3,500	5,000	2,500	2,800	1
MDWK4040T6R8MM	RoHS	6.8	±20%	0.158	0.138	2,900	4,000	2,000	2,300	1
MDWK4040T100MM	RoHS	10	±20%	0.194	0.169	2,200	3,100	1,600	1,900	1
MDWK4040T220MM	RoHS	22	±20%	0.460	0.400	1,500	2,100	1,200	1,400	1
MDWK4040T330MM	RoHS	33	±20%	0.720	0.625	1,200	1,700	800	1,000	1

MDPK5050 type

【Thickness:1.4mm max.】

	Nominal inductance		DC Resistance[Ω]		Rated current ※)[mA]				Measuring	
Parts number	EHS	[µ H]	Inductance tolerance	DO Nesistance[32]		Saturation current: Idc1		Temperature rise current: Idc2		frequency[MHz]
				Max.	Typ.	Max.	Typ.	Max.	Typ.	In equency [IIII I2]
MDPK5050T1R0MM	RoHS	1.0	±20%	0.040	0.034	8,500	10,000	4,300	4,700	1
MDPK5050T2R2MM	RoHS	2.2	±20%	0.055	0.047	4,100	5,000	3,600	4,200	1
MDPK5050T3R3MM	RoHS	3.3	±20%	0.086	0.073	3,800	4,500	2,900	3,400	1
MDPK5050T4R7MM	RoHS	4.7	±20%	0.102	0.088	3,500	4,200	2,500	3,000	1
MDPK5050T6R8MM	RoHS	6.8	±20%	0.138	0.12	2,700	3,200	2,200	2,500	1
MDPK5050T100MM	RoHS	10	±20%	0.225	0.19	2,200	2,600	1,700	2,000	1

%) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

X) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)

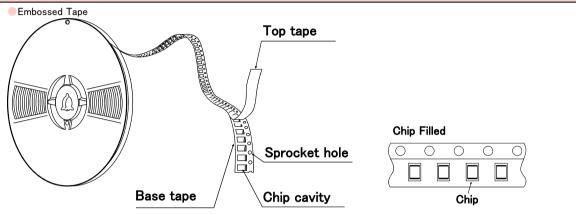
XX) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

PACKAGING

$\textcircled{1}{Minimum Quantity}$

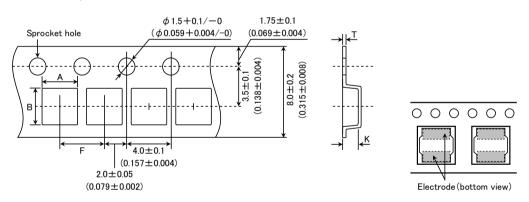
Туре	Standard Quantity [pcs]				
туре	Tape & Reel				
MDKK1616	2500				
MDJE2020					
MDKK2020	2500				
MDMK2020					
MDKK3030	2000				
MDMK3030	2000				
MDJE4040	1000				
MDMK4040	1000				
MDWK4040	700				
MDPK5050	1000				

2 Tape Material



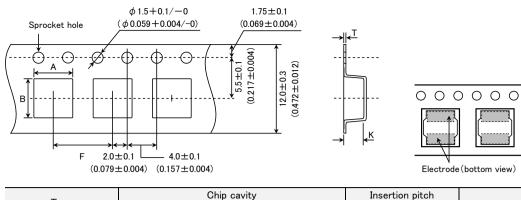
③Taping dimensions

Embossed tape 8mm wide (0.315 inches wide)



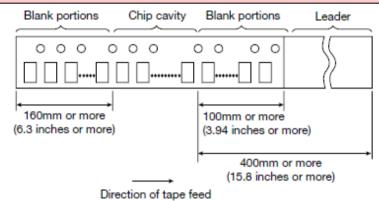
T	Chip	cavity	Insertion pitch	Insertion pitch Tape thickness	
Туре	A	В	F	Т	К
MDKK1616	1.79 ± 0.1 (0.071 ± 0.004)	1.79±0.1 (0.071±0.004)	4.0±0.1 (0.157±0.004)	0.25 ± 0.05 (0.010 ± 0.002)	1.1±0.1 (0.043±0.004)
MDJE2020 MDKK2020 MDMK2020	2.2 ± 0.1 (0.102 ± 0.004)	2.2±0.1 (0.102±0.004)	4.0±0.1 (0.157±0.004)	0.25 ± 0.05 (0.009 ± 0.002)	1.3±0.1 (0.051±0.004)
MDKK3030 MDMK3030	3.2±0.1 (0.126±0.004)	3.2 ± 0.1 (0.126 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.4 ± 0.1 (0.055 ± 0.004)
	-		•		Unit:mm(inch)

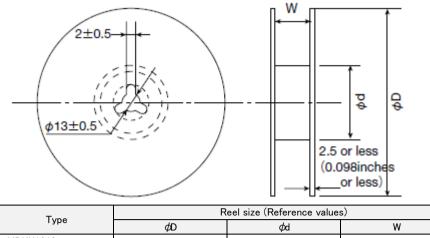
Embossed tape 12mm wide (0.47 inches wide)



Туре	Chip	cavity	Insertion pitch	Tape thickness		
Туре	A	В	F	Т	К	
MDJE4040	4.3±0.1	4.3±0.1	8.0±0.1	0.3 ± 0.05	1.6±0.1	
MDMK4040	(0.169 ± 0.004)	(0.169 ± 0.004)	(0.315 ± 0.004)	(0.012 ± 0.002)	(0.063 ± 0.004)	
MDWK4040	4.3±0.1	4.3±0.1	8.0±0.1	0.3 ± 0.05	2.3±0.1	
	(0.169 ± 0.004)	(0.169 ± 0.004)	(0.315 ± 0.004)	(0.012 ± 0.002)	(0.091 ± 0.004)	
	5.25 ± 0.1	5.25 ± 0.1	8.0±0.1	0.3±0.1	1.6±0.1	
MDPK5050	(0.207 ± 0.004)	(0.207 ± 0.004)	(0.315 ± 0.004)	(0.012 ± 0.004)	(0.063 ± 0.004)	
	•	•	•	•	Unit:mm(inch)	

④Leader and Blank portion





	φD	ϕ d	W
MDKK1616			
MDJE2020			
MDKK2020	180 ± 0.5	60 ± 1.0	10.0 ± 1.5
MDMK2020	(7.087±0.019)	(2.36 ± 0.04)	(0.394 ± 0.059)
MDKK3030			
MDMK3030			
MDJE4040			
MDMK4040	180 ± 3.0	60±2.0	14.0 ± 1.5
MDWK4040	(7.087±0.118)	(2.36 ± 0.08)	(0.551 ± 0.059)
MDPK5050			

Unit:mm(inch)

(6)Top Tape Strength

Top tape strength		
Туре	Peel-off strength	
MDKK1616		
MDJE2020		
MDKK2020	0.1N~1.0N	165°∼180° Pull direction
MDMK2020	0.1N~1.0N	Top tape
MDKK3030		
MDMK3030		
MDJE4040		
MDMK4040	0.1N-1.1.2N	Base tape
MDWK4040	0.1N~1.3N	
MDPK5050		

RELIABILITY DA	IA	
1 On eventions Too	nature Dance	
1. Operating Tempe Specified Value	MD series	-40~+125°C
Test Methods and		-40.0 + 123 C
Remarks	Including self-generated heat	
2. Storage Tempera	ture Range	
Specified Value	MD series	-40~+85°C
Test Methods and	-5 to 40°C for the product with taping.	
Remarks	o to to to for the product with taping.	
3. Rated current		T
Specified Value	MD series	Within the specified tolerance
4. Inductance		
Specified Value	MD series	Within the specified tolerance
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4 Measuring condition : Please see item li	4285A or equivalent) st.
5. DC Resistance		
Specified Value	MD series	Within the specified tolerance
Test Methods and Remarks	Measuring equipment : DC ohmmeter(H	IOKI 3227 or equivalent)
Remarks		
6. Self resonance fr	equency.	
Specified Value	MD series	_
7. Temperature cha	racteristic	
Specified Value	MD series	Inductance change : Within ±10%
Test Methods and		t temperature range within -40° C $\sim +125^{\circ}$ C.
Remarks	With reference to inductance value at $+20^\circ$	
8. Resistance to fle	xure of substrate	
Specified Value	MD series	No damage
	The test samples shall be soldered to the test until deflection of the test board reaches to Test board size : 100 × 40 × 1.0	
Test Methods and	Test board material : Glass epoxy-	
Remarks	Solder cream thickness : 0.10 mm	
		R5 Board 45±2mm
	I	
9. Insulation resista	nce : between wires	
Specified Value	MD series	-
	1	
10. Insulation resist	ance : between wire and core	

11. Withstanding vo	11. Withstanding voltage : between wire and core							
Specified Value	MD series	-						

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MD series

Specified Value

12. Adhesion of terminal electrode						
Specified Value	MD series		Shall not come off PC board			
	The test samples shall be soldered to the test board by the reflow.					
Test Methods and	Applied force	: 10N to X and `	Y directions.			
Remarks	Duration	: 5s.				
	Solder cream thickness	: 0.10mm.				

13. Resistance to vibration						
Specified Value	MD series		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.			
	The test samples shall be	soldered to the te	st board by the reflow.			
	Then it shall be submitted	to below test con	ditions.			
	Frequency Range	10~55Hz				
Test Methods and	Total Amplitude	1.5mm (May not	exceed acceleration 196m/s ²)			
Test Methods and Remarks	Sweeping Method	10Hz to 55Hz to	o 10Hz for 1min.			
Remarks		Х				
	Time	Y	For 2 hours on each X, Y, and Z axis.			
		Z				
	Recovery : At least 2hrs o	f recovery under t	he standard condition after the test, followed by the	e measurement within 48hrs.		

14. Solderability			
Specified Value	MD series		At least 90% of surface of terminal electrode is covered by new solder.
Tast Mathada and	The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table. Flux : Methanol solution containing rosin 25%.		
Test Methods and Remarks	Solder Temperature	245±5°C	
Remarks	Time	5±1.0 sec.	
	XImmersion depth : All sides of mounting terminal shall be immersed.		

15. Resistance to soldering heat			
Specified Value	MD series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.	
Test Methods and Remarks	The test sample shall be exposed to reflow oven at 230±5°C for 40 seconds, with peak temperature at 260±5°C for 5 seconds, 2 times Test board material : Glass epoxy-resin Test board thickness : 1.0mm		

16. Thermal shock				
Specified Value	MD series			nce change : Within $\pm 10\%$ ificant abnormality in appearance.
				y the reflow. The test samples shall be placed at specified temperature for specified quence. The temperature cycle shall be repeated 100 cycles.
	time by s	step I to step 4 as snown in b	elow table in seque	juence. The temperature cycle shall be repeated 100 cycles.
		Conditions of 1	cycle	
Test Methods and	Step	Temperature (°C)	Duration (m	(min)
Remarks	1	-40 ± 3	30±3	3
	2	Room temperature	Within 3	n 3
	3	$+85\pm2$	30±3	3
	4	Room temperature	Within 3	n 3

17. Damp heat			
Specified Value	MD series		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Test Methods and	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.		
Remarks	Temperature	60±2°C	
	Humidity	90~95%RH	
	Time	500+24/-0 hour	

18. Loading under damp heat				
Specified Value	MD series		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.	
Test Methods and	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated d continuously as shown in below table.			
Remarks	Temperature	60±2°C		
	Humidity	90~95%RH		
	Applied current	Rated current		
	Time	500+24/-0 hour		

19. Low temperatur	19. Low temperature life test			
Specified Value	MD series		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.	
Test Methods and	The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as s in below table.		board by the reflow. After that, the test samples shall be placed at test conditions as shown	
Remarks	Temperature	-40±2°C		
Time $500+24/-0$ hour		500+24/-0 hour		

20. High temperature life test		
Specified Value	MD series	-

21. Loading at high temperature life test			
Specified Value	MD series		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
Test Methods and	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and applied the rated current continuously as shown i below table.		
Remarks	Temperature	85±2°C	
	Applied current	Rated current	
	Time	500+24/-0 hour	

22. Standard condition		
Specified Value	MD series	Standard test condition : Unless otherwise specified, temperature is $20\pm15^{\circ}$ C and $65\pm20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20\pm2^{\circ}$ C of temperature, $65\pm5\%$ relative humidity. Inductance is in accordance with our measured value.

PRECAUTIONS

1. Circuit Design	
Precautions	 Operating environment The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

Precautions	 ◆Land pattern design 1. Please refer to a recommended land pattern.
Technical considerations	 Land pattern design Surface Mounting Mounting and soldering conditions should be checked beforehand. Applicable soldering process to this products is reflow soldering only.

3. Considerations	3. Considerations for automatic placement		
Precautions	 Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. 		
Technical considerations	♦Adjustment of mounting machine When installing products, care should be taken not to apply distortion stress as it may deform the products. 		

4. Soldering	
Precautions	 Reflow soldering Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. The product shall be used reflow soldering only. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. Lead free soldering When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. Recommended conditions for using a soldering iron (NR10050 Type) Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration - 3 seconds or less The soldering iron should not directly touch the inductor.
Technical considerations	 Reflow soldering If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

5. Cleaning		
Precautions	 Cleaning conditions 1. Washing by supersonic waves shall be avoided. 	
Technical considerations	 Cleaning conditions 1. If washed by supersonic waves, the products might be broken. 	

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For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).



6. Handling	6. Handling		
Precautions	 Handling Keep the product away from all magnets and magnetic objects. Breakaway PC boards (splitting along perforations) When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. Board separation should not be done manually, but by using the appropriate devices. Mechanical considerations Please do not give the product any excessive mechanical shocks. Please do not add any shock and power to a product in transportation. Pick-up pressure Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. Packing Please avoid accumulation of a packing box as much as possible. Board mounting There shall be no pattern or via between terminals at the bottom of product. 		
Technical considerations	 Handling There is a case that a characteristic varies with magnetic influence. Breakaway PC boards (splitting along perforations) The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. Mechanical considerations There is a case to be damaged by a mechanical shock. There is a case to be broken by the handling in transportation. Pick-up pressure Damage and a characteristic can vary with an excessive shock or stress. Packing If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products. Board mounting If there is pattern or via between terminals at the bottom of product, it may cause characteristics change. If components which are located in peripheral of product make contact with surface (top, side) of product, it may cause damage or characteristics change. 		

7. Storage conditions		
Precautions	 Storage To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions	
Technical considerations	 Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. 	



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